BT05AG

5-4000 MHz Wideband Drive Amplifier

Device Features

- OIP3 = 40.0 dBm @ 1900 MHz
- Gain = 20.8 dB @ 900 MHz
- Output P1 dB = 22.4 dBm @ 900 MHz
- 50 Ω Cascadable
- Lead-free/RoHS-compliant SOT-89 SMT package

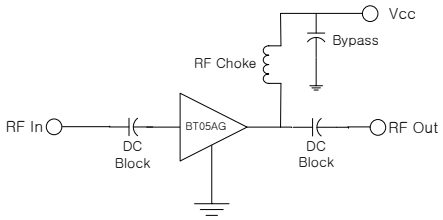
Product Description

BeRex's BT05AG is a high performance and a high dynamic range amplifier in a low cost surface mount package(SOT-89) with a RoHS -compliant, that incorporates reliable heterojunction-bipolar-transistor (HBT) devices fabricated with InGaP GaAs technology. This device is designed for use where high linearity is required and features high OIP3 and P1 with low consumption current (85mA) and requires a few external matching components such as a DC blocking capacitors on the In/Output pin, a bypass capacitor and a RF choke for the out port. All devices are 100% RF/DC tested.

Applications

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system

Application Circuits



*external matching circuit: refer to the page 5 to 11.

Typical Performance[1]

Parameter	Frequency				Unit
	900	1900	2450	3500	MHz
Gain	20.8	16.3	14.3	11.1	dB
S11	-14.0	-20.0	-22.0	-16.0	dB
S22	-12.0	-12.0	-12.0	-13.0	dB
OIP3[2]	37.0	40.0	37.5	40.0	dBm
P1dB	22.4	19.5	23.0	22.8	dBm
Noise Figure	4.5	4.4	4.3	4.5	dB

[1] Device performance _ measured on a BeRex evaluation board at 25°C, 50 Ω system.

[2] OIP3 _ measured with two tones at an output of 10 dBm per tone separated by 1 MHz.

	Min.	Typical	Max.	Unit
Bandwidth	5		4000	MHz
I_C @ (Vc = 5V)	75	85	95	mA
V_C		5.0		V
R_{TH}		50		°C/W

Absolute Maximum Ratings

Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	°C
Storage Temperature	-55 to +155	°C
Junction Temperature	+220	°C
Operating Voltage	+7.0	V
Supply Current	180	mA
Input RF Power	23	dBm

*Operation of this device above any of these parameters may result in permanent damage.

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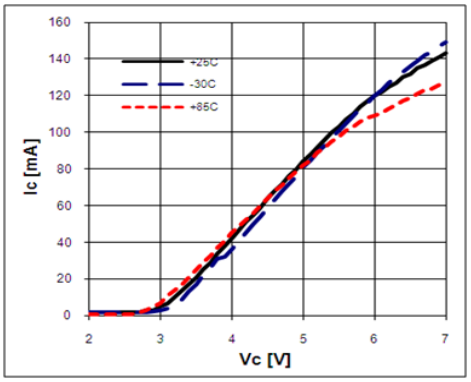
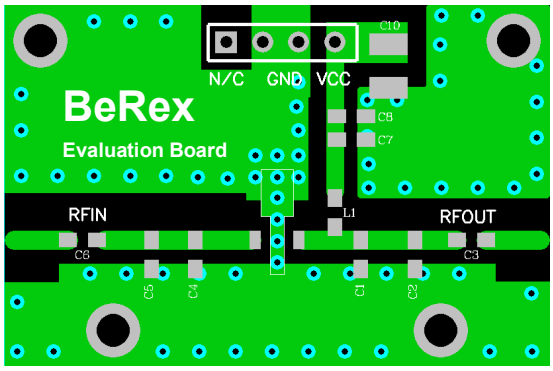
V-I Characteristics



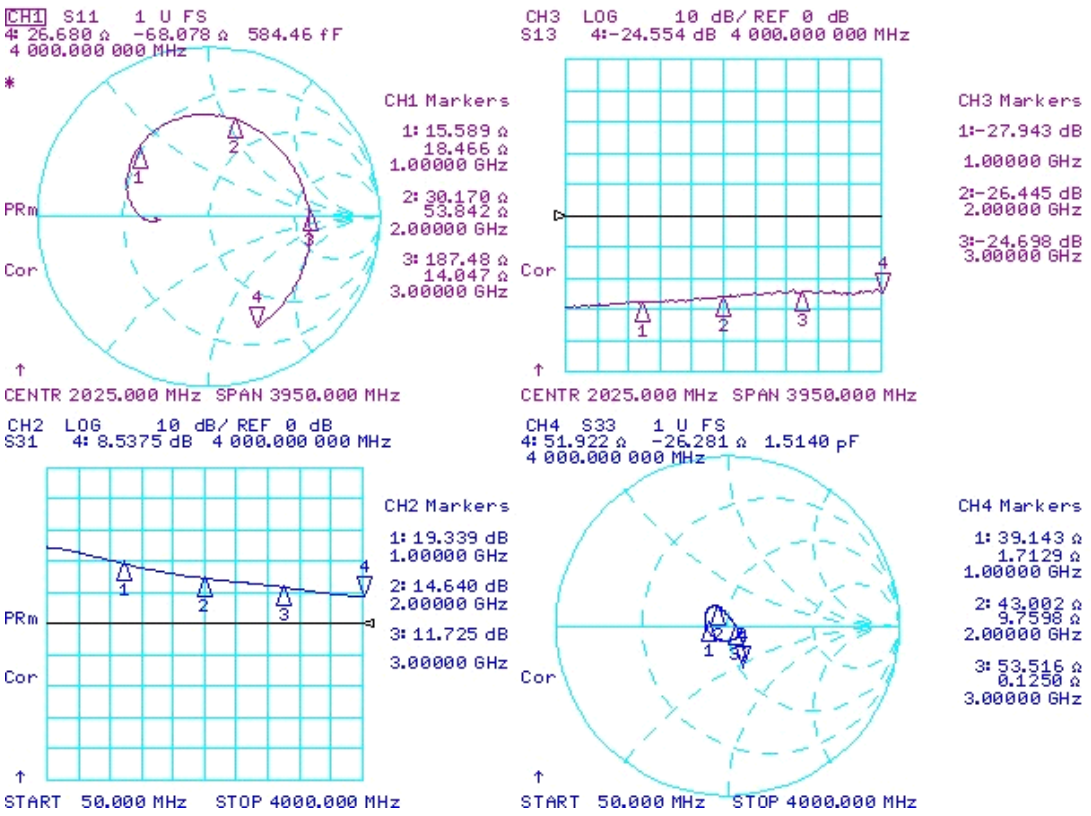
BeRex SOT89 Evaluation Board



*Dielectric constant _ 4.2 *RF pattern width 52mil *31mil thick FR4 PCB

Typical Device Data

S-parameters (Vc=5V, Ic=84mA, T=25°C)



BT05AG

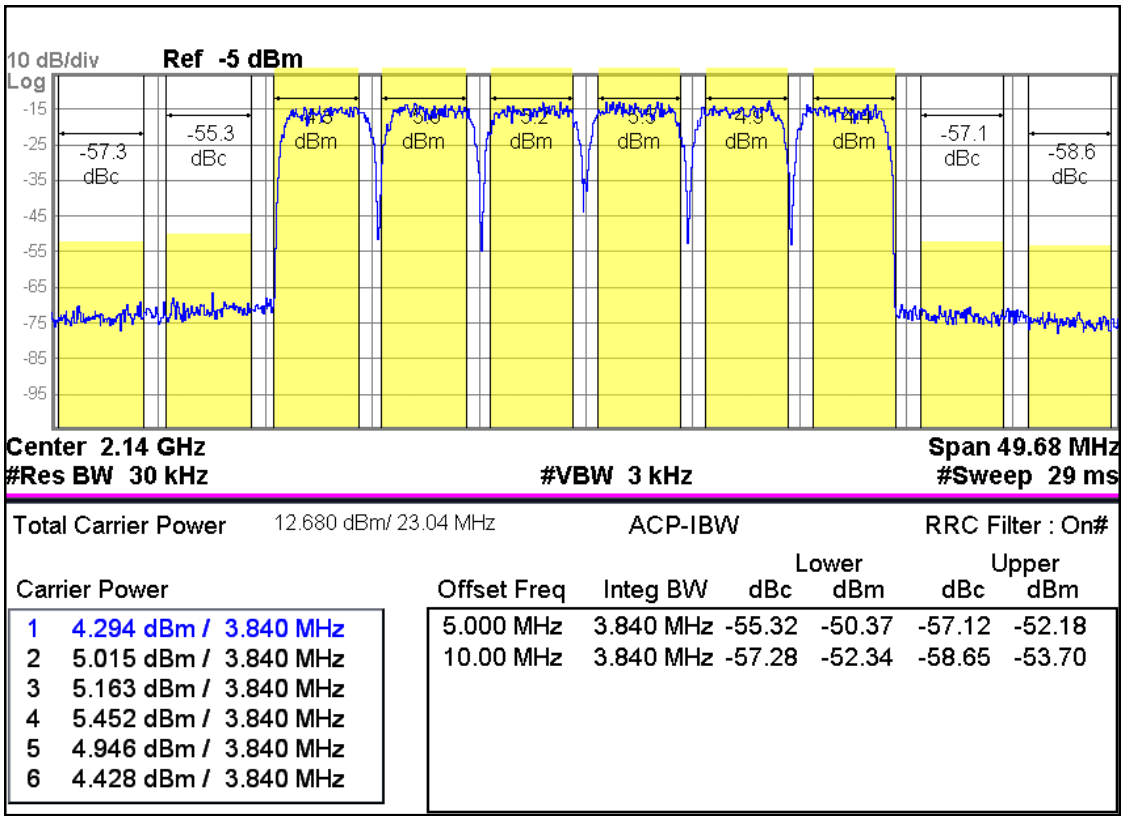
5-4000 MHz Wideband Drive Amplifier

S-Parameter

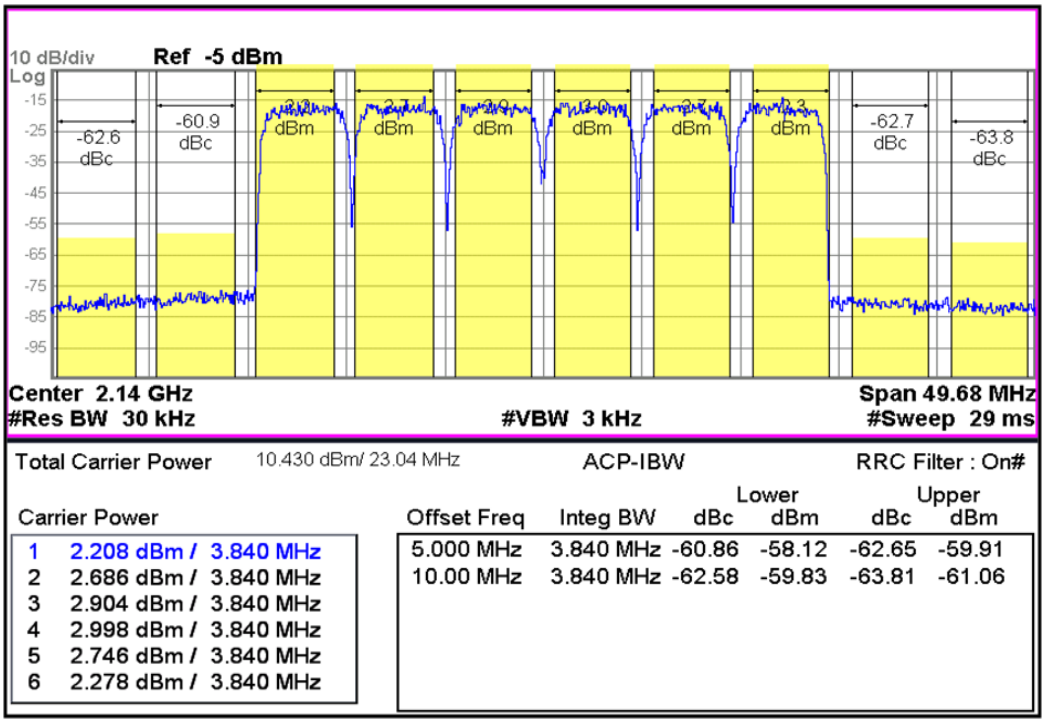
(Vdevice = 5.0V, Icc = 84mA, T = 25 °C, calibrated to device leads)

Freq [MHz]	S11 Mag	S11 Ang	S21 Mag	S21 Ang	S12 Mag	S12 Ang	S22 Mag	S22 Ang
100	-10.6001	-176.08	24.3773	166.26	-29.173	-0.828	-21.805	-27.056
500	-6.89632	171.969	22.4951	118.889	-28.510	-5.512	-20.525	-120.815
1000	-4.83571	137.774	19.3111	75.4763	-27.637	-16.88	-17.519	170.039
1500	-4.36842	107.055	16.5624	42.7846	-27.010	-29.70	-16.447	137.451
2000	-4.49519	77.2739	14.5732	13.4329	-26.080	-41.79	-17.536	118.289
2500	-4.82222	43.2334	13.1214	-15.725	-25.166	-58.33	-22.101	99.7268
3000	-4.64574	3.39018	11.7047	-45.735	-24.318	-79.25	-27.037	4.66192
3500	-3.85543	-35.846	9.92492	-74.765	-25.101	-100.4	-16.664	-50.8784
4000	-3.0184	-66.883	8.4767	-100.82	-24.247	-119.41	-11.732	-71.031

WCDMA 6FA 2140 -55dBc



WCDMA 6FA 2140 -60dBc

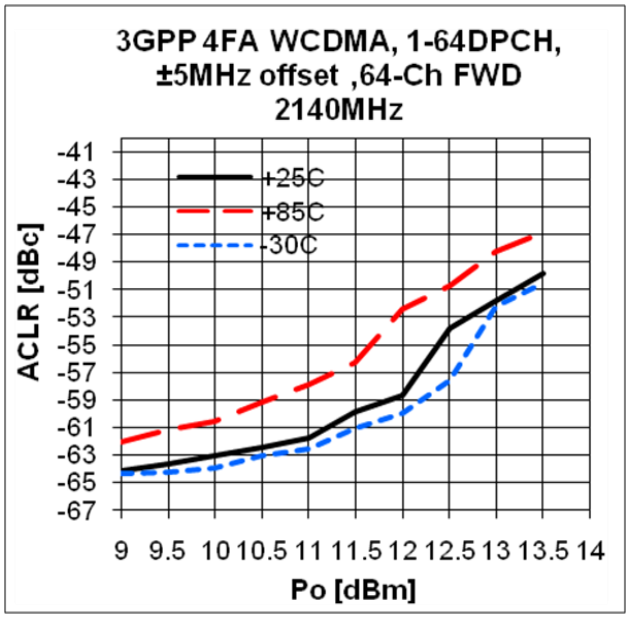


Total Carrier Power 10.430 dBm/ 23.04 MHz ACP-IBW RRC Filter : On#

Carrier Power		
1	2.208 dBm /	3.840 MHz
2	2.686 dBm /	3.840 MHz
3	2.904 dBm /	3.840 MHz
4	2.998 dBm /	3.840 MHz
5	2.746 dBm /	3.840 MHz
6	2.278 dBm /	3.840 MHz

Offset Freq	Integ BW	Lower dBc	Lower dBm	Upper dBc	Upper dBm
5.000 MHz	3.840 MHz	-60.86	-58.12	-62.65	-59.91
10.00 MHz	3.840 MHz	-62.58	-59.83	-63.81	-61.06

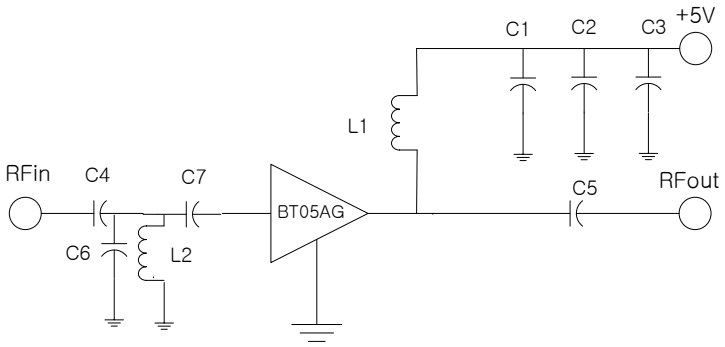
ACLR

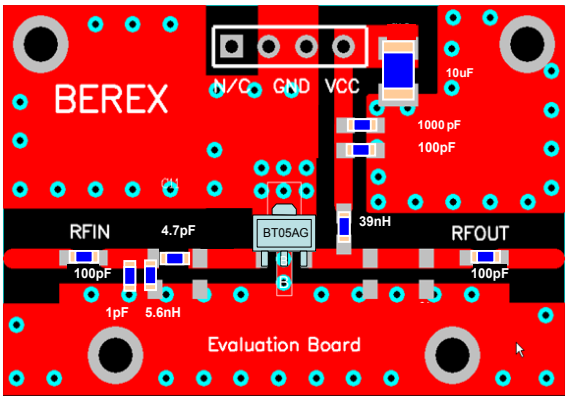


BT05AG

5-4000 MHz Wideband Drive Amplifier

Application Circuit: 900 MHz

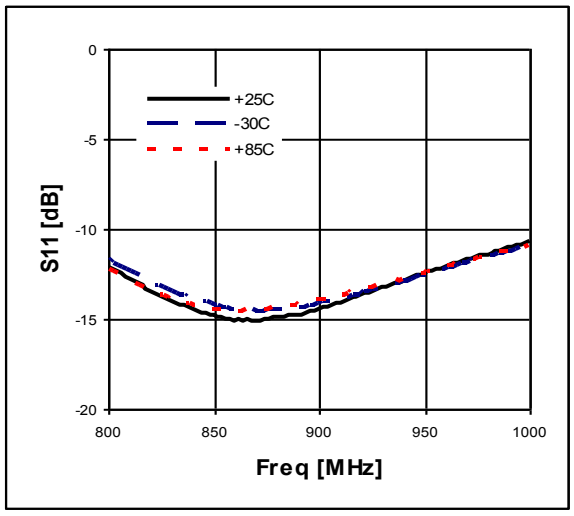
Schematic Diagram	BOM		Tolerance
	C1	100pF	±5%
	C2	1000pF	±5%
	C3	10uF	±20%
	C4	100pF	±5%
	C5	100pF	±5%
	C6	1pF	±5%
	C7	4.7pF	±5%
	L1	39nH	±5%
	L2	5.6nH	±5%

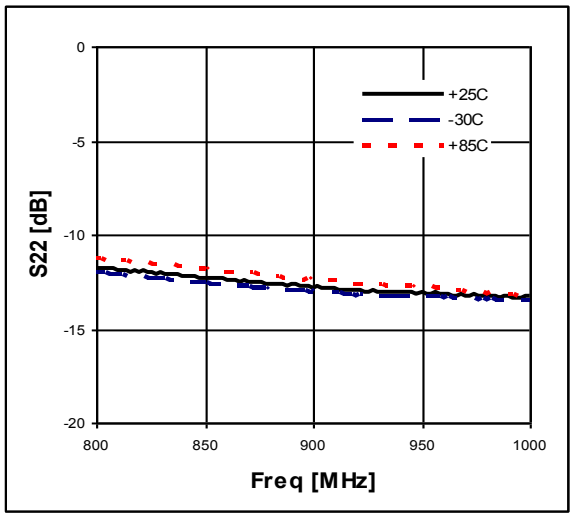


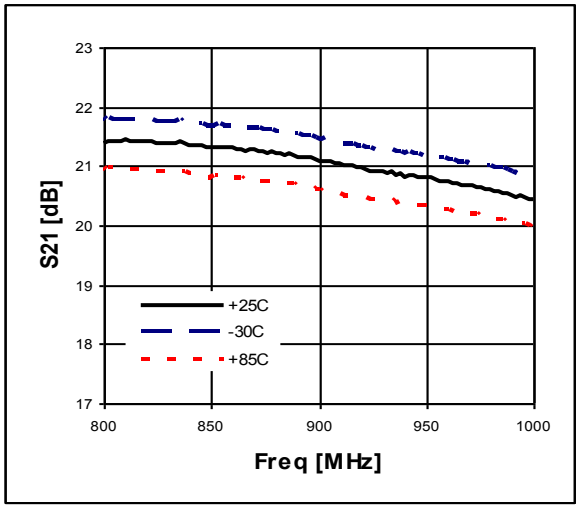
Note:

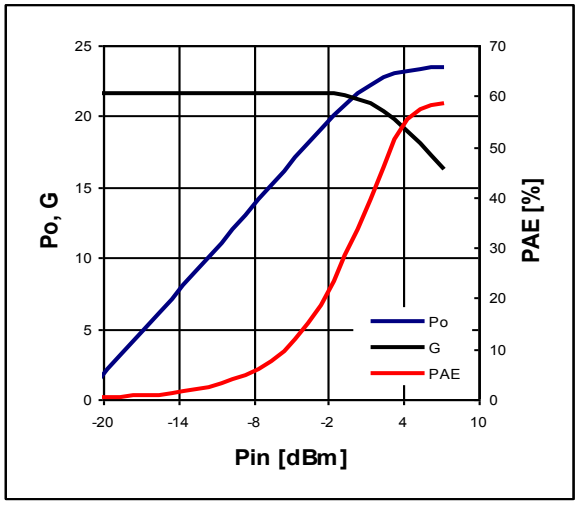
1. PCB: 31mil thick FR4
2. Distance between the center of the series cap (C7) and the input pin of BT05AG _ ***2.0mm.***
3. Distance between the center of the shunt inductor(L2) and the input pin of BT05AG _ ***4.1mm.***
4. Distance between the center of the shunt cap (C6) and the input pin of BT05AG _ ***6.5mm.***

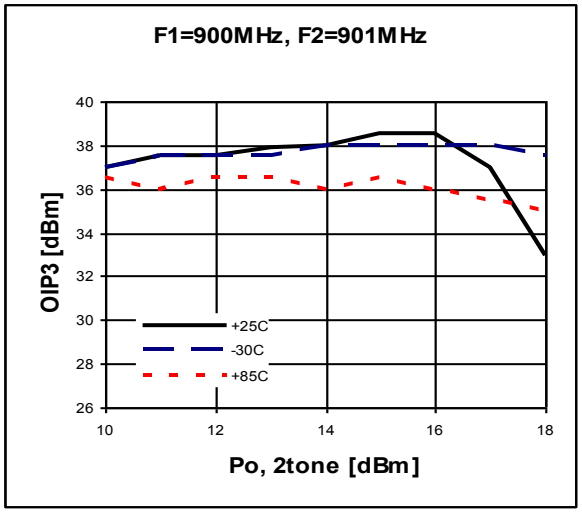
Typical Performance

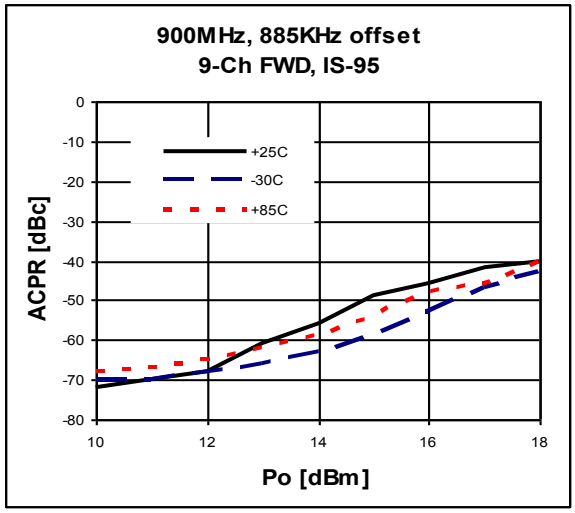








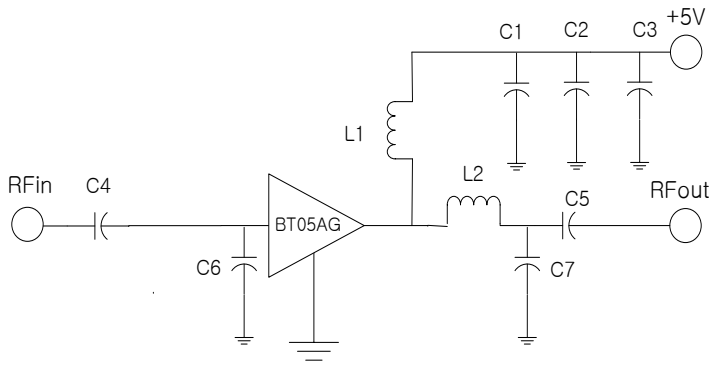


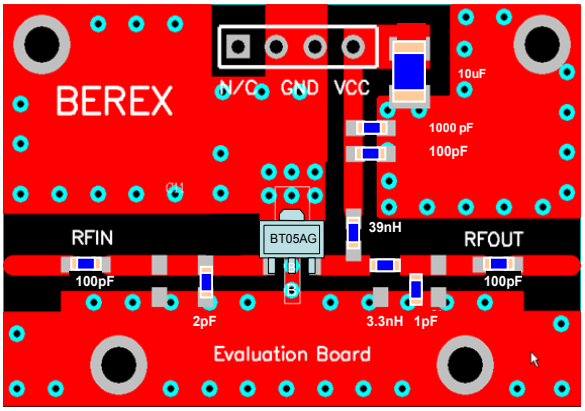


BT05AG

5-4000 MHz Wideband Drive Amplifier

Application Circuit: 1900 MHz

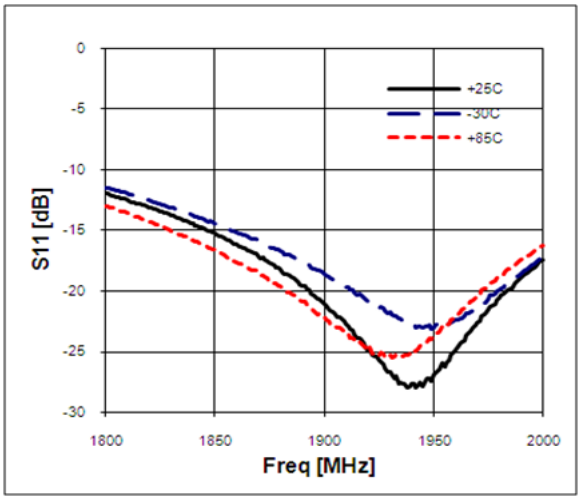
Schematic Diagram	BOM		Tolerance
	C1	100pF	±5%
	C2	100pF	±5%
	C3	10uF	±20%
	C4	100pF	±5%
	C5	100pF	±5%
	C6	2pF	±5%
	C7	1pF	±5%
	L1	39nH	±5%
	L2	3.3nH	±5%

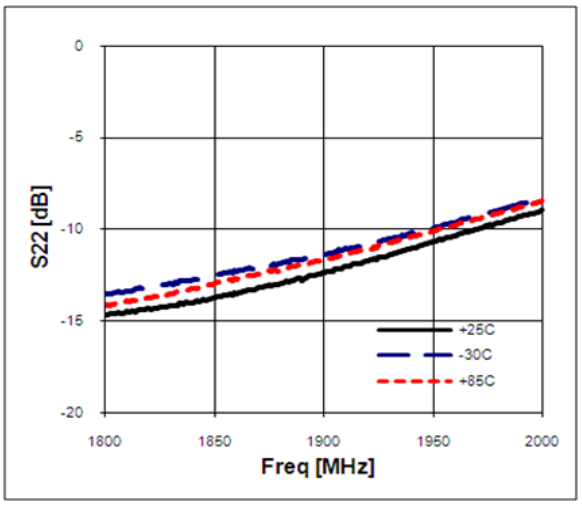


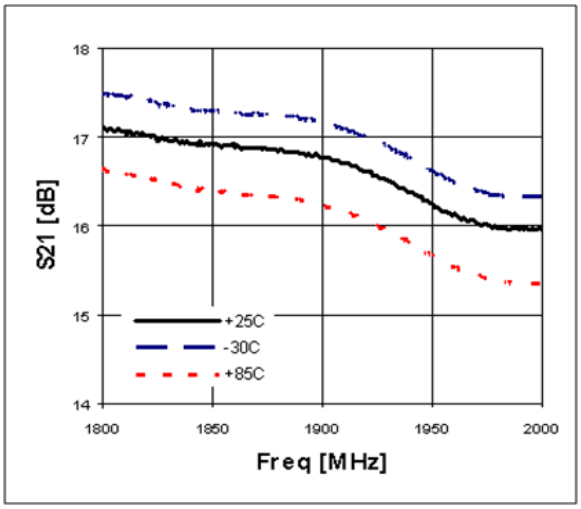
Note:

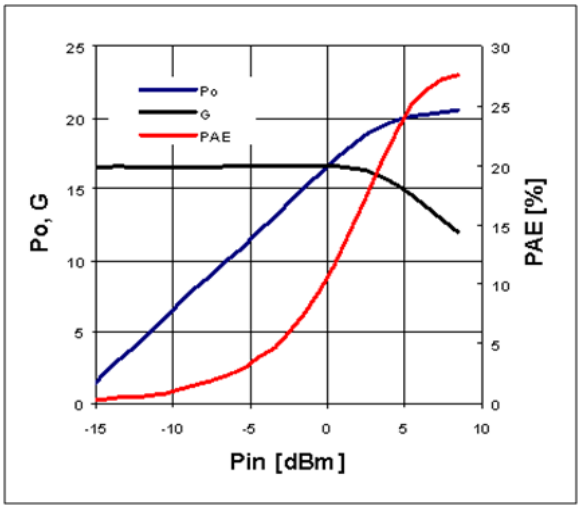
1. PCB: 31mil thick FR4
2. Distance between the center of the shunt cap (C6) and the input pin of BT05AG _ ***1.8mm.***
3. Distance between the center of the series inductor(L2) and the output pin of BT05AG _ ***3.5mm.***
4. Distance between the center of the shunt cap (C7) and the output pin of BT05AG _ ***5.9mm.***

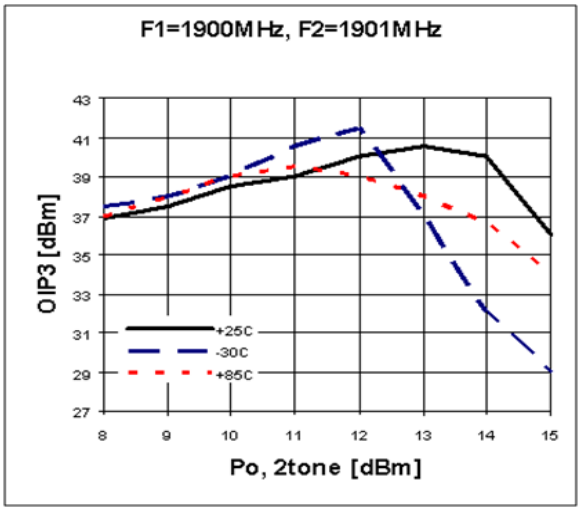
Typical Performance

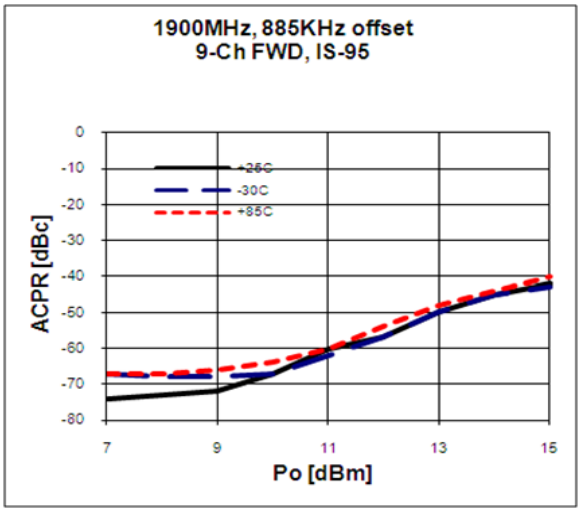




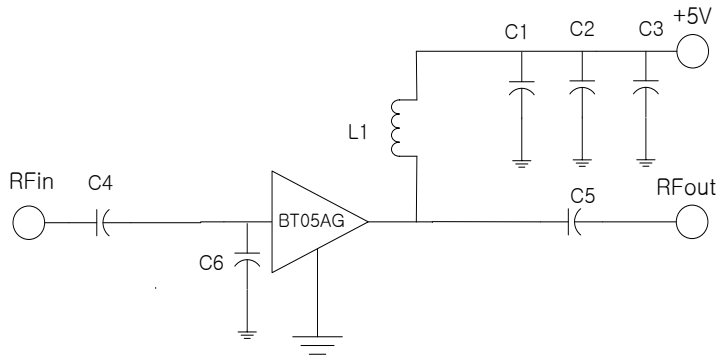


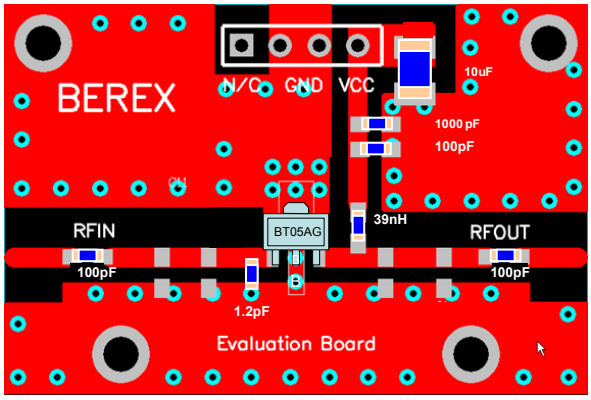






Application Circuit: 2450MHz

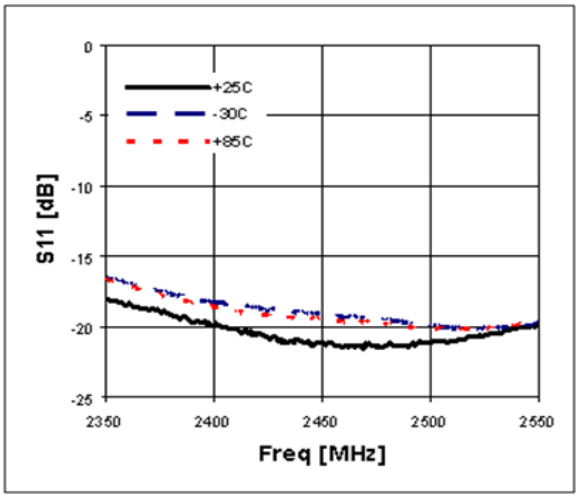
Schematic Diagram	BOM		Tolerance
	C1	100pF	±5%
	C2	1000pF	±5%
	C3	10uF	±20%
	C4	100pF	±5%
	C5	100pF	±5%
	C6	1.2pF	±5%
	L1	39nH	±5%

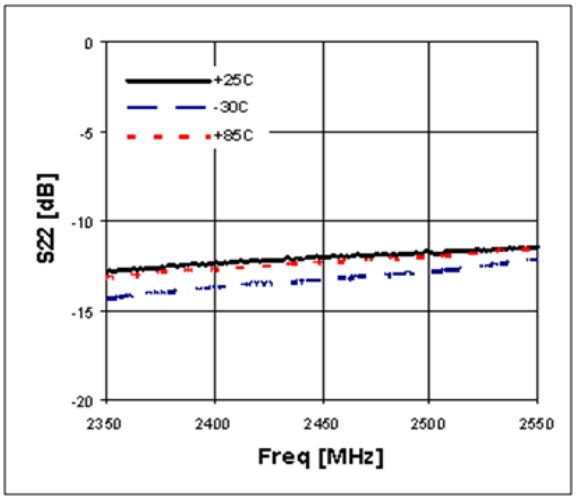


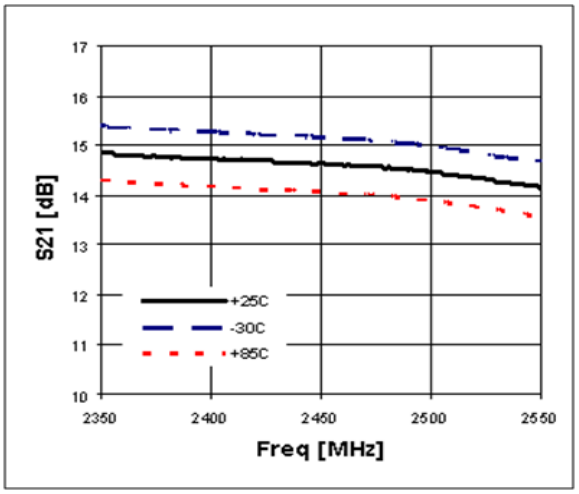
Note:

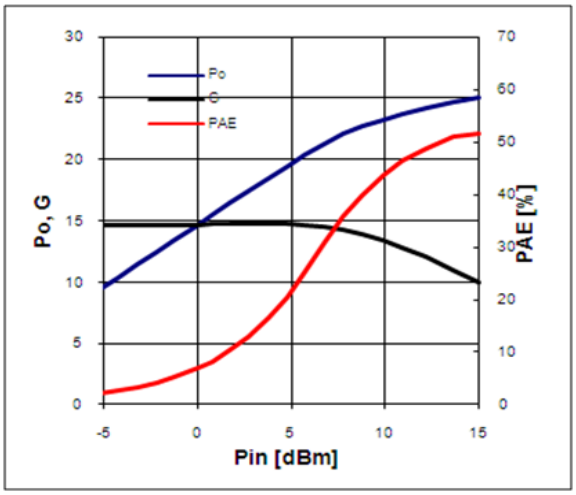
1. PCB: 31mil thick FR4
2. Distance between the center of the shunt cap (C6) and the input pin of BT05AG _ ***0.5mm.***

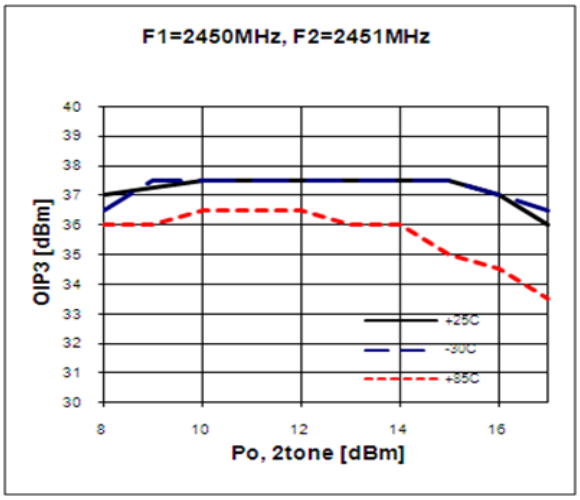
Typical Performance



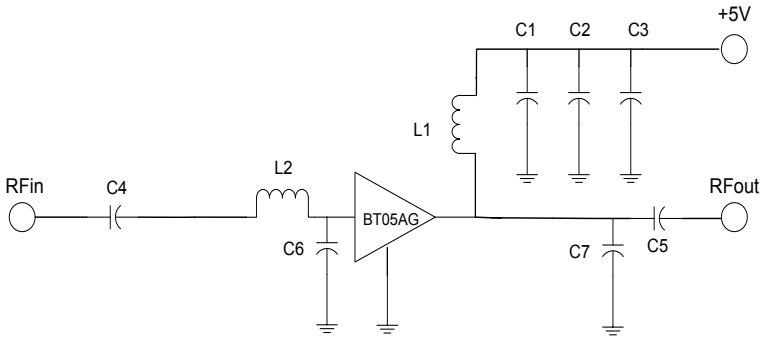


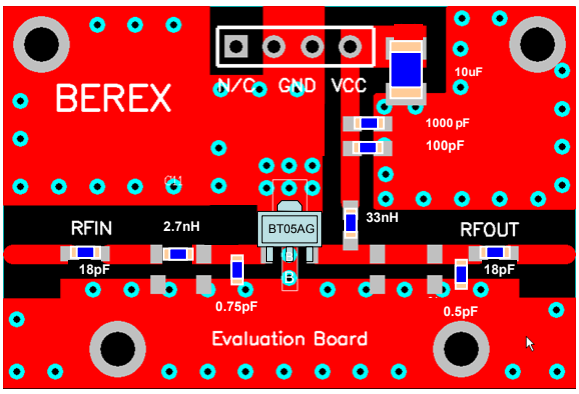






Application Circuit: 3500MHz

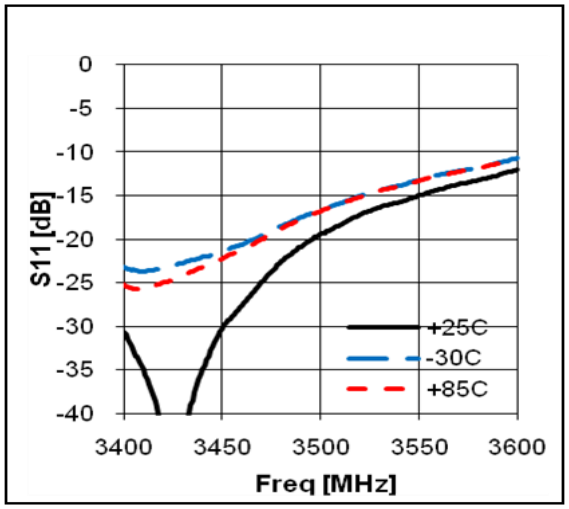
Schematic Diagram	BOM		Tolerance
	C1	100pF	±5%
	C2	1000pF	±5%
	C3	10uF	±20%
	C4	18pF	±5%
	C5	18pF	±5%
	C6	0.75pF	±5%
	C7	0.5pF	±5%
	L1	33nH	±5%
	L2	2.7nH	±5%

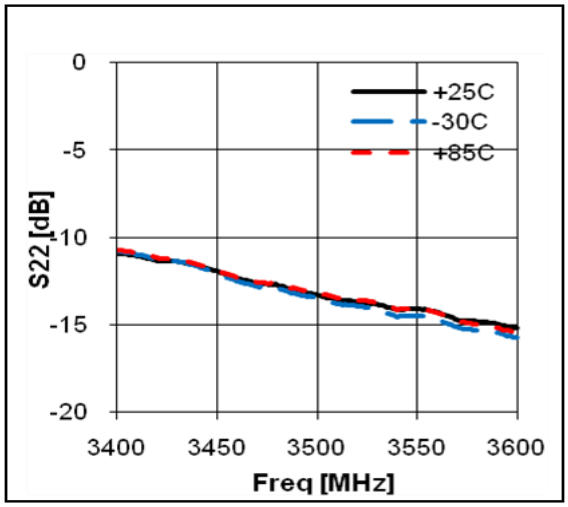


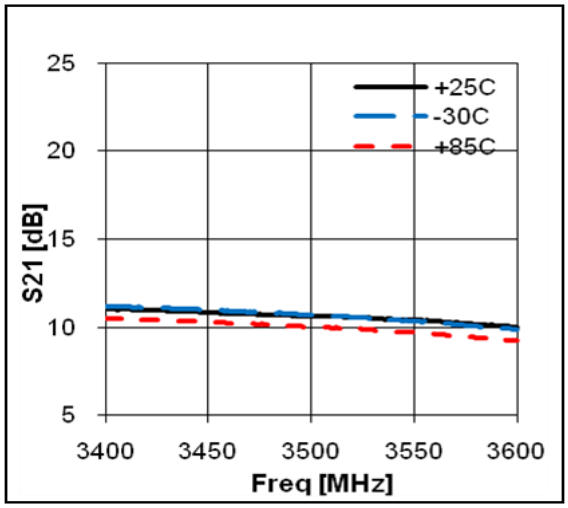
Note:

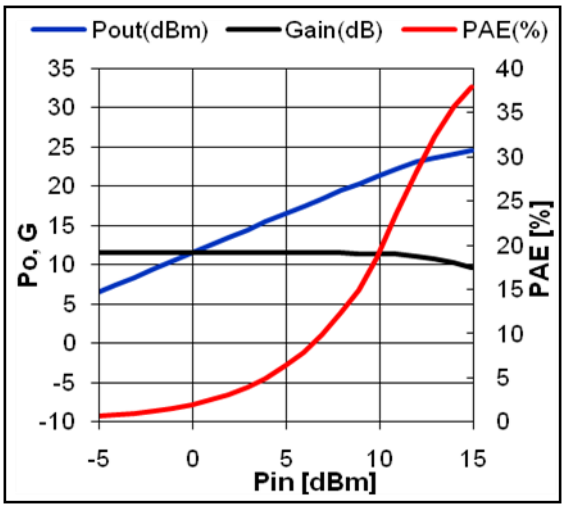
1. PCB: 31mil thick FR4
2. Distance between the center of the series inductor(L2) and the input pin of BT05AG _ ***2.0mm.***
3. Distance between the center of the shunt cap(C6) and the input pin of BT05AG _ ***0.5mm.***
4. Distance between the center of the shunt cap(C7) and the output pin of BT05AG _ ***10.0mm.***

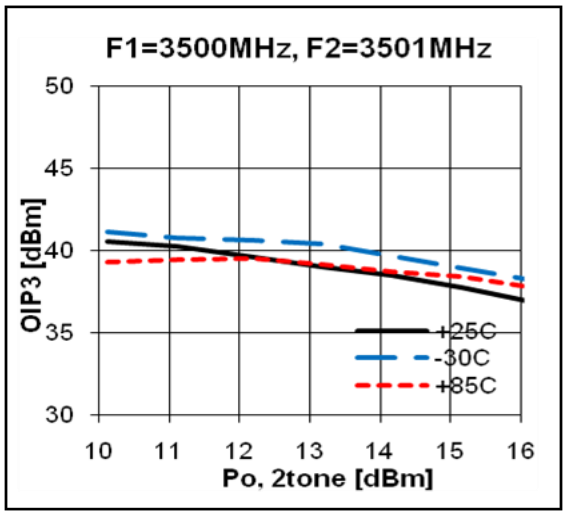
Typical Performance



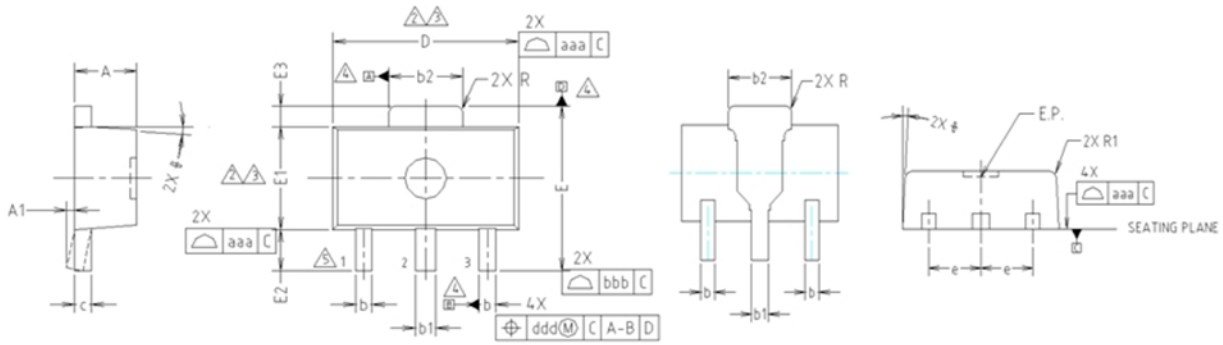








Package Outline Dimension



NOTE:

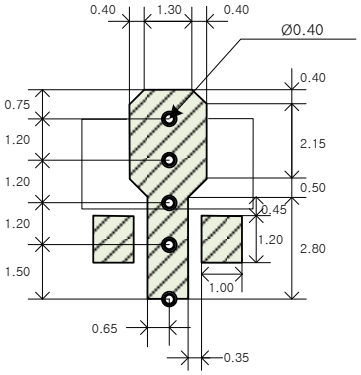
1. DIMENSIONS IN MILLIMETERS.
2. DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.5mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.5mm PER SIDE.
3. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
4. DATUMS A, B AND D TO BE DETERMINED 0.18mm FROM THE LEAD TIP.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A	1.40	1.50	1.60	
A1	0.00	–	0.10	
b	0.38	0.42	0.48	
b1	0.48	0.52	0.58	
b2	1.79	1.82	1.87	
c	0.40	0.42	0.46	
D	4.40	4.50	4.70	2,3
E	3.70	4.00	4.30	
E1	2.40	2.50	2.70	2,3
E2	0.80	1.00	1.20	
E3	0.40	0.50	0.60	
e	1.50 TYP.			
θ	4° TYP.			
R	0.15 TYP.			
R1	–	–	0.20	

SYMBOL	TOLERANCES OF FORM AND POSITION	NOTE
aaa	0.15	
bbb	0.20	
ccc	0.10	
ddd	0.10	

Suggested PCB Land Pattern and PAD Layout

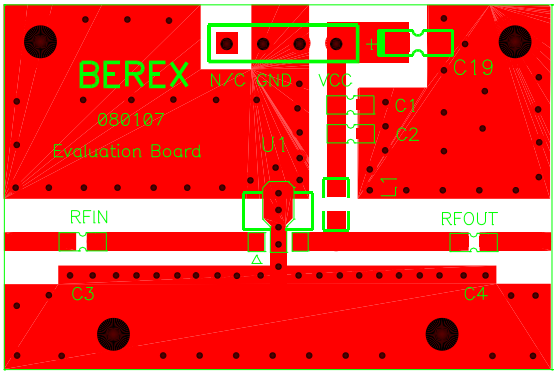
PCB Land Pattern



Note : All dimension _ millimeters

PCB lay out _ on BeRex website

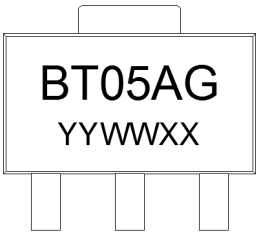
PCB Mounting



BT05AG

5-4000 MHz Wideband Drive Amplifier

Package Marking

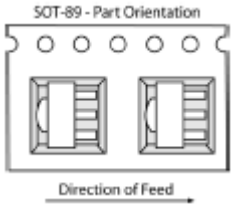


Pin 1

YY = Year, WW = Working Week,
XX = Wafer No.

Tape & Reel

SOT89



Packaging information:

Tape Width (mm): 12

Reel Size (inches): 7

Device Cavity Pitch (mm): 8

Devices Per Reel: 1000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating:	Class 1B
Value:	**Passes <1000V**
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114B
MSL Rating:	**Level 1 at +265°C convection reflow**
Standard:	JEDEC Standard J-STD-020

NATO CAGE code:

2	**N**	**9**	**6**	**F**